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Sharp Microelectronics PR29MF21NSZ

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SHARP

PR29MF21NSZ Series PR39MF2xNSZ Series

*Non-zero cross type is also available.
(PR29MF1xNSZ Series/PR39MF1xNSZ Series)

I_T(rms)≤0.9A, Zero Cross type DIP 8pin Triac output SSR



■ Description

PR29MF21NSZ Series and **PR39MF2xNSZ Series** Solid State Relays (SSR) are an integration of an infrared emitting diode (IRED), a Phototriac Detector and a main output Triac. These devices are ideally suited for controlling high voltage AC loads with solid state reliability while providing $4.0\,\mathrm{kV}$ isolation ($V_{iso}(rms)$) from input to output.

■ Features

- 1. Output current, I_T(rms)≤0.9A
- 2. Zero crossing functionary (V_{OX} : MAX. 35V)
- 3. 8 pin DIP package (SMT gullwing also available)
- 4. High repetitive peak off-state voltage

 $(V_{DRM}:600V,$ **PR39MF2xNSZ Series**)

(V_{DRM}: 400V, PR29MF21NSZ Series)

- 5. I_{FT} ranks available (see Model Line-up in this datasheet)
- 6. Superior noise immunity (dV/dt : MIN. 100V/µs)
- 7. Response time, ton: MAX. 50μs
- 8. Lead-free terminal components are also available (see Model Line-up section in this datasheet)
- 9. High isolation voltage between input and output (V_{iso}(rms) : 4.0kV)

■ Agency approvals/Compliance

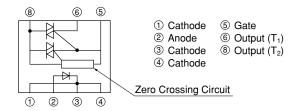
- Recognized by UL508, file No. E94758 (as model No. R29MF2/R39MF2)
- Approved by CSA 22.2 No.14, file No. LR63705 (as model No. R29MF2/R39MF2)
- Optionary available VDE approved (*)(DIN EN 60747-5-2), file No. 40008898 (only for PR39MF2xNSZ Series as model No. R39MF2)
- 4. Package resin: UL flammability grade (94V-0)
 - (*) DIN EN60747-5-2: successor standard of DIN VDE0884. Up to Date code "RD" (December 2003), approval of DIN VDE0884.

From Date code "S1" (January 2004), approval of DIN EN60747-5-2.

■ Applications

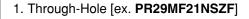
- Isolated interface between high voltage AC devices and lower voltage DC control circuitry.
- 2. Switching motors, fans, heaters, solenoids, and valves.
- 3. Power control in applications such as lighting and temperature control equipment.

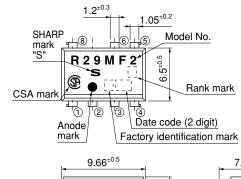
■ Internal Connection Diagram

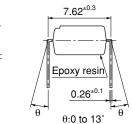


■ Outline Dimensions

(Unit: mm)



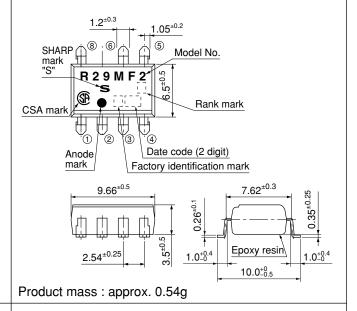




Product mass: approx. 0.56g

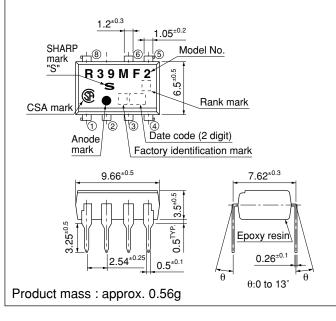
 $25^{\pm0.5}$

2. SMT Gullwing Lead-Form [ex. PR29MF21NIPF]

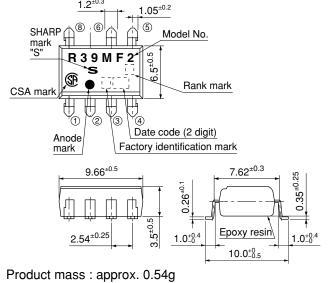


3. Through-Hole [ex. PR39MF21NSZF]

 $0.5^{\pm0.1}$



4. SMT Gullwing Lead-Form [ex. PR39MF21NIPF] $1.2^{\pm0.3}$

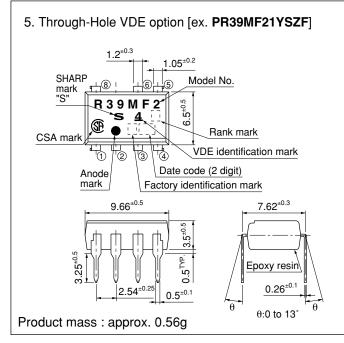


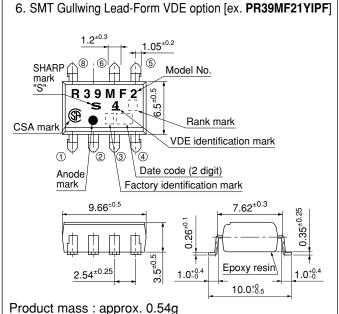
Datasheet of PR29MF21NSZ - RELAY SSR 120VAC .9A ZC 8-DIP Datasheet of PR29MF21NSZ - KELAT SON 125000 ISSUE OF TRANSPORTED TO THE CONTROL OF THE CONTROL OF TRANSPORTED TO THE CONTROL OF THE CONTROL OF TRANSPORTED TO THE CONTROL OF THE CONTROL OF TRANSPORTED TO THE CONTROL O

PR39MF2xNSZ Series

■ Outline Dimensions

(Unit: mm)





Datasheet of PR29MF21NSZ - RELAY SSR 120VAC .9A ZC 8-DIP

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PR29MF21NSZ Series

PR29MF21NSZ Series



PR39MF2xNSZ Series

Date code (2 digit)

	1st o	digit		2nd digit		
	Year of p	roduction		Month of production		
A.D.	Mark	A.D	Mark	Month	Mark	
1990	A	2002	P	January	1	
1991	В	2003	R	February	2	
1992	С	2004	S	March	3	
1993	D	2005	T	April	4	
1994	Е	2006	U	May	5	
1995	F	2007	V	June	6	
1996	Н	2008	W	July	7	
1997	J	2009	X	August	8	
1998	K	2010	A	September	9	
1999	L	2011	В	October	0	
2000	M	2012	С	November	N	
2001	N	i i	:	December	D	

repeats in a 20 year cycle

Factory identification mark

Factory identification Mark	Country of origin
no mark	Tomon
	Japan

^{*} This factory marking is for identification purpose only.

Please contact the local SHARP sales representative to see the actural status of the production.

Rank mark

Please refer to the Model Line-up table.



Datasheet of PR29MF21NSZ - RELAY SSR 120VAC .9A ZC 8-DIP

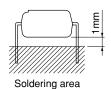


PR39MF2xNSZ Series

■ Absolute Maximum Ratings

 $(T_a=25^{\circ}C)$

	(-a)								
	Parameter	Symbol	Rating	Unit					
T4	Forward current		I_{F}	50 *3	mA				
Input	Reverse voltage		V_R	6	V				
	RMS ON-state cu	rrent	I _T (rms)	0.9 *3	A				
0-44	Peak one cycle su	rge current	I _{surge}	9 *4	A				
Output	Repetitive	PR29MF21NSZ		400	* 7				
	peak OFF-state voltage	PR39MF2xNSZ	VDRM	600	V				
*1 Isolatic	on voltage		V _{iso} (rms)	4.0	kV				
Operati	ing temperature	Topr	-30 to +85	°C					
Storage	e temperature	T_{stg}	-40 to +125	°C					
*2Solderi	ng temperature		T_{sol}	270 *5	°C				



■ Electro-optical Characteristics

 $(T_a=25^{\circ}C)$

	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
T	Forward voltage		V_F	I _F =20mA	_	1.2	1.4	V
Input	Reverse current		I_R	$V_R=3V$	_	-	10	μΑ
	Repetitive peak OFF-state c	urrent	I_{DRM}	$V_D = V_{DRM}$	_	_	100	μΑ
	ON-state voltage		V_{T}	I _T =0.9A	_	_	3.0	V
Outmut	Holding current		I_{H}	$V_D=6V$	_	_	25	mA
Output	Critical rate of rise of OFF-state voltage		dV/dt	$V_D=1/\sqrt{2} \cdot V_{DRM}$	100	_	-	V/µs
	Zero cross voltage	Rank 1	- V _{OX}	I _F =15mA, Resistance load	_	_	35	V
		Rank 2		I _F =10mA, Resistance load				
	Minimum tui aaan ayanant	Rank 1	т	V- 6V P- 1000	_	_	10	A
Transfer characteristics	Minimum trigger current	Rank 2	Ift	$V_D=6V, R_L=100\Omega$	_	_	5	mA
	Isolation resistance		R _{ISO}	DC500V,40 to 60%RH	5×10 ¹⁰	10^{11}	_	Ω
	Turn-on time	Rank 1	+	I_F =20mA, V_D =6V, R_L =100 Ω		_	50	
	1 um-on ume	Rank 2	t _{on}	$I_F=10mA, V_D=6V, R_L=100\Omega$	_			μs

^{*1 40} to 60%RH, AC for 1minute, f=60Hz

^{*2} For 10s

^{*3} Refer to Fig.1, Fig.2 *4 f=50Hz sine wave *5 Lead solder plating models: 260°C

Datasheet of PR29MF21NSZ - RELAT SSK 1207GC .S. LECT Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com PR29MF21NSZ Series PR39MF2xNSZ Series

■ Model Line-up (1) (Lead-free terminal components)

Lead Form	Through-Hole		SMT G	ullwing			
Chinaina Dadaaa	Sleeve		Taping		V_{DRM}		I _{FT} [mA]
Shipping Package	50pcs/sleeve		1 000pcs/reel			Rank mark	$(V_D=6V,$
DIN					[V]		$R_L=100\Omega$)
EN60747-5-2		Approved		Approved			
	PR39MF21NSZF	PR39MF21YSZF	PR39MF21NIPF	PR39MF21YIPF	600	1	MAX.10
Model No.	PR39MF22NSZF	PR39MF22NSZF PR39MF22YSZF		PR39MF22YIPF	600	2	MAX.5
	PR29MF21NSZF		PR29MF21NIPF		400	1	MAX.10

■ Model Line-up (2) (Lead solder plating components)

Lead Form	Throug	gh-Hole	SMT Gullwing					
C1: ' D 1	Sleeve		Taping		V_{DRM}	Rank mark	$I_{FT}[mA]$ ($V_D=6V$,	
Shipping Package	50pcs/sleeve		1 000pcs/reel					
DIN					[V]		$R_L=100\Omega$)	
EN60747-5-2		Approved		Approved				
	PR39MF21NSZ	PR39MF21YSZ			600	1	MAX.10	
Model No.	PR39MF22NSZ	PR39MF22YSZ			600	2	MAX.5	
	PR29MF21NSZ	<u> </u>			400	1	MAX.10	

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Fig.1 Forward Current vs. Ambient **Temperature**

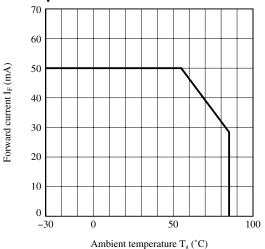


Fig.3-a Forward Current vs. Forward Voltage (Rank 1)

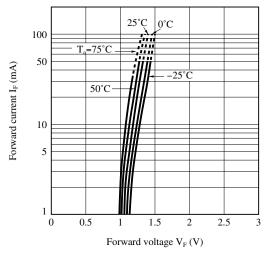


Fig.4-a Minimum Trigger Current vs. Ambient Temperature (Rank 1)

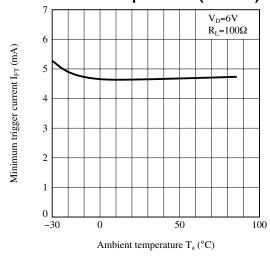


Fig.2 RMS ON-state Current vs. **Ambient Temperature**

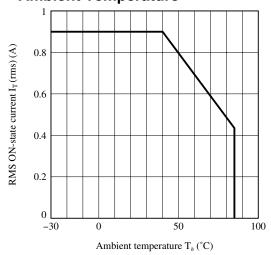


Fig.3-b Forward Current vs. Forward Voltage (Rank 2)

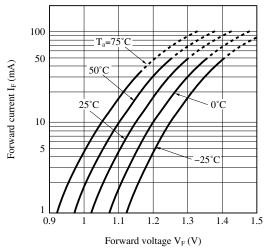


Fig.4-b Minimum Trigger Current vs. **Ambient Temperature (Rank 2)**

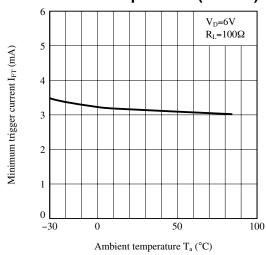




Fig.5 ON-state Voltage vs.

Ambient Temperature

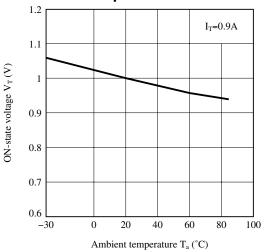


Fig.7 Zero-cross Voltage vs. Ambient Temperature

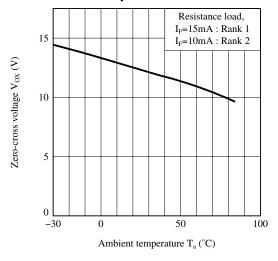


Fig.9-a Turn-on Time vs.
Forward Current (Rank 1)

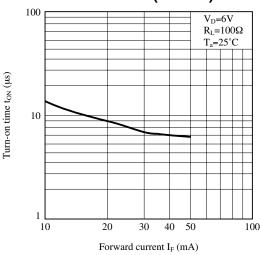
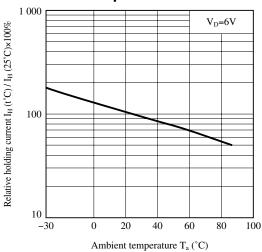


Fig.6 Relative Holding Current vs.

Ambient Temperature



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Fig.8 ON-state Current vs. ON-state Voltage

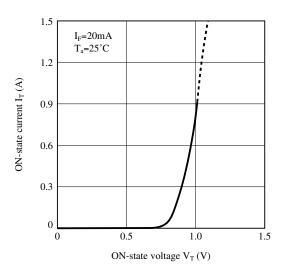
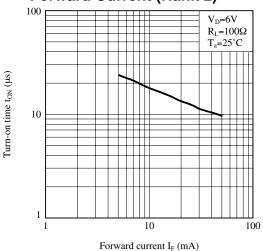


Fig.9-b Turn-on Time vs.
Forward Current (Rank 2)



Remarks: Please be aware that all data in the graph are just for reference.



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■ Design Considerations

Recommended Operating Conditions

	Parameter			Symbol	Conditions	MIN.	MAX.	Unit
Input	Input signal current Ran		Rank 1	I (ON)		20	25	mA
	at ON state		Rank 2	$I_F(ON)$	_	10	15	ША
	Input signal current at OFF state		I _F (OFF)	_	0	0.1	mA	
	I and aumnly voltage	PR29MF	21NSZ	V (mma)			120	*7
	Load supply voltage	PR39MF2xNSZ		$V_{OUT}(rms)$	_	_	240	v
Output	Load supply current		I _{OUT} (rms)	Locate snubber circuit between output terminals $(Cs\text{=}0.022\mu F,Rs\text{=}47\Omega)$	-	$I_T(rms) \times 80\%(^*)$	mA	
	Frequency		f	_	50	60	Hz	
Operati	Operating temperature			T_{opr}	-	-20	80	°C

^(*) See Fig.2 about derating curve ($I_T(rms)$ vs. ambient temperature).

Design guide

In order for the SSR to turn off, the triggering current (I_F) must be 0.1mA or less.

Particular attention needs to be paid when utilizing SSRs that incorporate zero crossing circuitry.

If the phase difference between the voltage and the current at the output pins is large enough, zero crossing type SSRs cannot be used. The result, if zero crossing SSRs are used under this condition, is that the SSR may not turn on and off irregardless of the input current. In this case, only a non zero cross type SSR should be used in combination with the above mentioned snubber circuit selection process.

When the input current (I_F) is below 0.1mA, the output Triac will be in the open circuit mode. However, if the voltage across the Triac, V_D, increases faster than rated dV/dt, the Triac may turn on. To avoid this situation, please incorporate a snubber circuit. Due to the many different types of load that can be driven, we can merely recommend some circuit values to start with : Cs=0.022μF and Rs=47Ω. The operation of the SSR and snubber circuit should be tested and if unintentional switching occurs, please adjust the snubber circuit component values accordingly.

When making the transition from On to Off state, a snubber circuit should be used ensure that sudden drops in current are not accompanied by large instantaneous changes in voltage across the Triac.

This fast change in voltage is brought about by the phase difference between current and voltage.

Primarily, this is experienced in driving loads which are inductive such as motors and solenods.

Following the procedure outlined above should provide sufficient results.

For over voltage protection, a Varistor may be used.

Any snubber or Varistor used for the above mentioned scenarios should be located as close to the main output triac as possible.

All pins shall be used by soldering on the board. (Socket and others shall not be used.)

Degradation

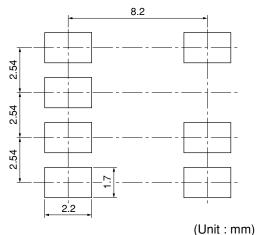
In general, the emission of the IRED used in SSR will degrade over time.

In the case where long term operation and / or constant extreme temperature fluctuations will be applied to the devices, please allow for a worst case scenario of 50% degradation over 5years.

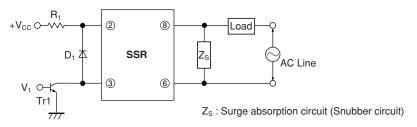
Therefore in order to maintain proper operation, a design implementing these SSRs should provide at least twice the minimum required triggering current from initial operation.

Recommended Foot Print (reference)

SMT Gullwing Lead-form



Standard Circuit



Datasheet of PR29MF21NSZ - RELAY SSR 120VAC .9A ZC 8-DIP

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■ Manufacturing Guidelines

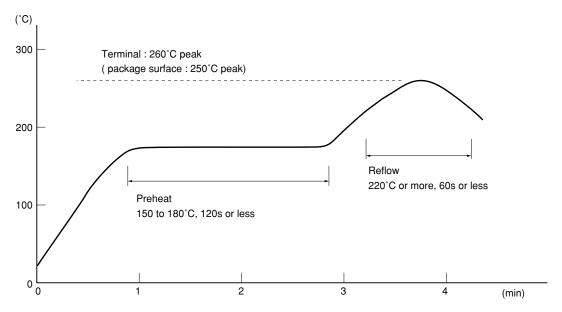
Soldering Method

Reflow Soldering:

Reflow soldering should follow the temperature profile shown below.

Soldering should not exceed the curve of temperature profile and time.

Please don't solder more than twice.



Flow Soldering:

Flow soldering should be completed below 270°C and within 10s.

Preheating is within the bounds of 100 to 150°C and 30 to 80s.

Please don't solder more than twice.

Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C.

Please don't solder more than twice.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



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Cleaning instructions

Solvent cleaning:

Solvent temperature should be 45°C or below. Immersion time should be 3minutes or less.

Ultrasonic cleaning:

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials:

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol.

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances: CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.

Datasheet of PR29MF21NSZ - KELAT SGN 125V/13

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PR39MF2xNSZ Series



■ Package specification

Sleeve package **Through-Hole**

Package materials

Sleeve: HIPS (with anti-static material)

Stopper: Styrene-Elastomer

Package method

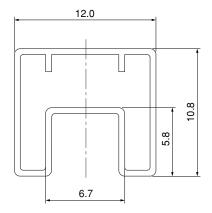
MAX. 50pcs of products shall be packaged in a sleeve.

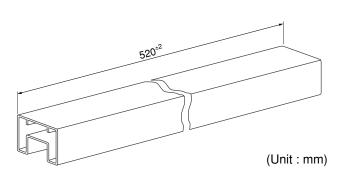
Both ends shall be closed by tabbed and tabless stoppers.

The product shall be arranged in the sleeve with its anode mark on the tabless stopper side.

MAX. 20 sleeves in one case.

Sleeve outline dimensions





● Tape and Reel package SMT Gullwing

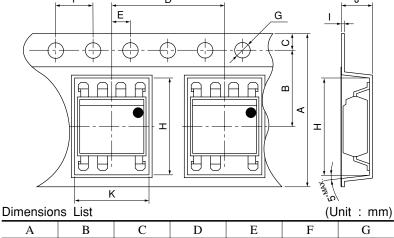
Package materials

Carrier tape: A-PET (with anti-static material)

Cover tape: PET (three layer system)

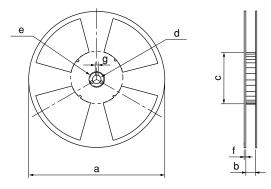
Reel: PS

Carrier tape structure and Dimensions



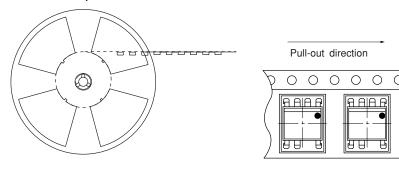
Difficion	IO LIGI		()	····· · · · · · · · · · · · · · · · ·		
A	В	C	D	Е	F	G
16.0±0.3	7.5 ^{±0.1}	1.75 ^{±0.1}	12.0 ^{±0.1}	2.0 ^{±0.1}	4.0 ^{±0.1}	φ1.5 + 8.1
Н	I	J	K			
10.4 ^{±0.1}	0.4 ^{±0.05}	4.2 ^{±0.1}	10.2 ^{±0.1}			

Reel structure and Dimensions



Dimensio	ns List	(Unit: mm)			
a	b	c	d		
330	17.5 ^{±1.5}	100±1.0	13±0.5		
e	f	g			
23 ^{±1.0}	2.0 ^{±0.5}	2.0 ^{±0.5}			

Direction of product insertion



[Packing: 1 000pcs/reel]

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- (i) The devices in this publication are designed for use in general electronic equipment designs such as:
 - --- Personal computers
 - --- Office automation equipment
 - --- Telecommunication equipment [terminal]
 - --- Test and measurement equipment
 - --- Industrial control
 - --- Audio visual equipment
 - --- Consumer electronics
- (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

with equipment that requires higher reliability such as:

- --- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.
- (iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
 - --- Space applications
 - --- Telecommunication equipment [trunk lines]
 - --- Nuclear power control equipment
 - --- Medical and other life support equipment (e.g., scuba).
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